Solid-State Light. Done Right.

APPROVAL SHEET

AOT MODEL NAME	3006
AOT PART NUMBER	3006C-W30F
CUSTOMER NAME	General
DATE	2021 / Oct
Version	01

MAKER			CUSTOMER			
Prepared	Checked	Approved				
Sam Kuo	***Claire Hung***	***Sinfan Lo***				

AOT Headquarters
No. 13, Gongye 5th. Road, Hsinchu Industrial Park, Hukou Shiang,
Hsinchu Hsien 303, Taiwan, R.O.C.
TEL: +886-3-597-6988 / FAX: +886-3-598-7392

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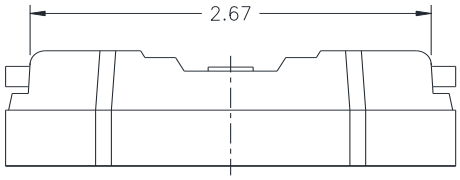
Revision Note

Date	Revision	Page	Version
2021-10-15	Initiate Document	-	01

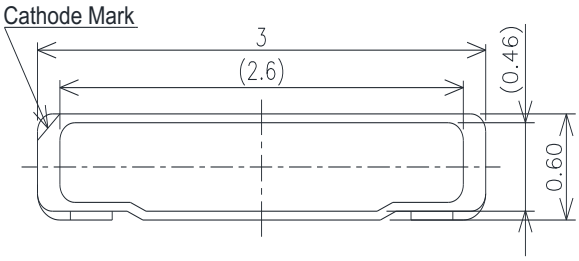
Package Outline

Model name: **3006C-W30F**
Unit: mm, Tolerance: ± 0.1 mm

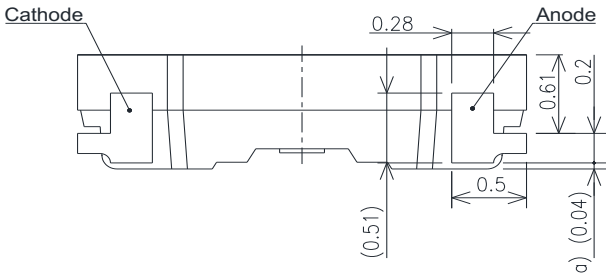
Front view



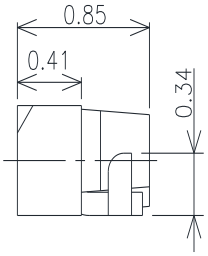
Top view



Back view



Side view



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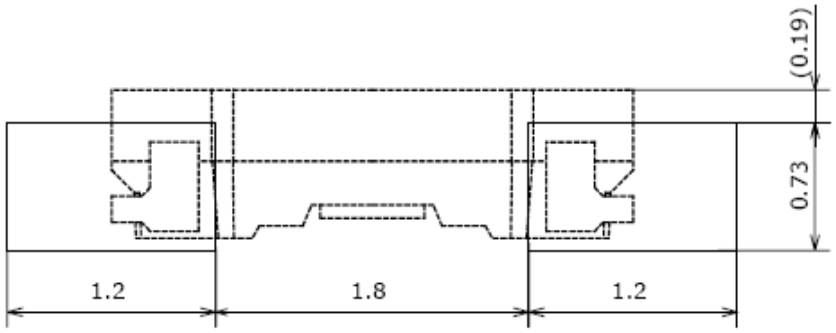
Recommended Soldering Pad design (Unit :mm)



(単位 Unit: mm)

Item	Materials
Package	High Temperature Resistant Plastic, PPA.
Encapsulating	Silicone Resin(with phosphor)
Electrode	Cu Alloy With Ni, Ag Plating.

- SMD type Side-View white LED.
- Lead frame package with individual 2 pins.
- Wide viewing angle(120°)
- Compatible with reflow soldering.
- Complies with RoHS Directive.
- The Encapsult surface should be under the package surface, and should not expose the wire.
- Compact package outline (L x W x H) of 3.0 mm x 0.85mm x 0.6 mm.

Optical/Electronic Characteristics (T_A=25˚C)

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V_F	I_F =20mA	2.7	-	3	V
Luminous Flux	Φ_V	I_F =20mA	7.00	-	11.00	lm
Reverse Current	I_R	V_R= -7V	-	-	0.05	μA

* Tolerance of measurements of the Forward Voltage is ± 0.05 V.
* Tolerance of measurements of the Luminous Flux is ± 5%.

Absolute Maximum Ratings (T_A=25˚C)

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	I_F	30	mA
Peak Forward Current (Duty 1/10@ 10ms)	I_{PF}	100	mA
***Reverse Voltage**	V_R	5	V
Power Dissipation	P_D	90	mW
Operating Temperature	T_{opr}	-40~+85	˚C
Storage Temperature	T_{stg}	-40~+100	˚C
Soldering Temperature	T_{sld}	Reflow Soldering : 260˚C for 10sec Hand Soldering : 350˚C for 3sec	
Junction Temperature	Tj	105	˚C
Forward Voltage at Low Current	VF2	>1.9 (@1μA)	V

* I_{FP} Conditions: Pulse Width ≤ 10msec, and duty ≤ 1/10

* Max condition is not guarantee for life time

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Group Definition of Forward Voltage

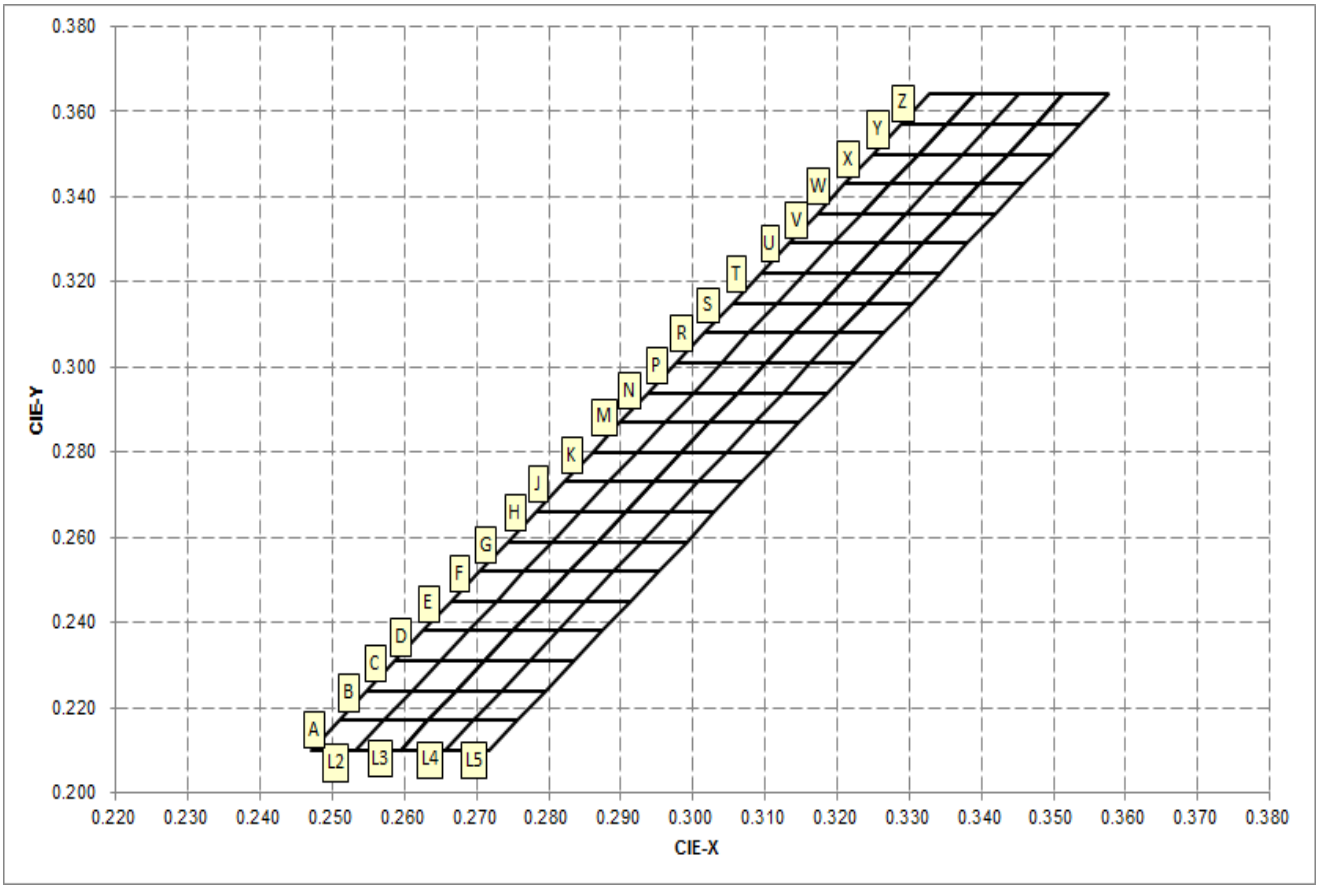
Rank		Condition	VF(V)	
VLL	V7	T_A=25˚C I_F=20mA	2.7	2.8
	V8		2.8	2.9
VL	V9		2.9	3.0

Group Definition of Brightness

Rank	Condition	Luminous Intensity	
		ϕ v (lm)	
		Min.	Max.
NW700	T_A=25˚C I_F=20mA	7.00	7.25
NW725		7.25	7.50
NW750		7.50	7.75
NW775		7.75	8.00
NW800		8.00	8.25
NW825		8.25	8.50
NW850		8.50	8.75
NW875		8.75	9.00
NW900		9.00	9.25
NW925		9.25	9.50
NW950		9.50	9.75
NW975		9.75	10.00
NW1000		10.00	10.25
NW1025		10.25	10.50
NW1050		10.50	10.75
NW1075		10.75	11.00

*A shipment shall consist of LEDs in a combination of above ranks.
* The percentage of each rank in the shipment shall be determined by AOT.
*The ranking information of LEDs can be found on the reel label.

Group Definition of Chromaticity Coordinate



Rank	x	y	Rank	x	y	Rank	x	y
AL2	0.2470	0.2100	FL2	0.2665	0.2450	ML2	0.2860	0.2800
	0.2509	0.2170		0.2704	0.2520		0.2899	0.2870
	0.2571	0.2170		0.2766	0.2520		0.2961	0.2870
	0.2532	0.2100		0.2727	0.2450		0.2922	0.2800
BL2	0.2509	0.2170	GL2	0.2704	0.2520	NL2	0.2899	0.2870
	0.2548	0.2240		0.2743	0.2590		0.2938	0.2940
	0.2610	0.2240		0.2805	0.2590		0.3000	0.2940
	0.2571	0.2170		0.2766	0.2520		0.2961	0.2870
CL2	0.2548	0.2240	HL2	0.2743	0.2590	PL2	0.2938	0.2940
	0.2587	0.2310		0.2782	0.2660		0.2977	0.3010
	0.2649	0.2310		0.2844	0.2660		0.3039	0.3010
	0.2610	0.2240		0.2805	0.2590		0.3000	0.2940
DL2	0.2587	0.2310	JL2	0.2782	0.2660	RL2	0.2977	0.3010
	0.2626	0.2380		0.2821	0.2730		0.3016	0.3080
	0.2688	0.2380		0.2883	0.2730		0.3078	0.3080
	0.2649	0.2310		0.2844	0.2660		0.3039	0.3010

EL2	0.2626	0.2380	KL2	0.2821	0.2730	SL2	0.3016	0.3080
	0.2665	0.2450		0.2860	0.2800		0.3055	0.3150
	0.2727	0.2450		0.2922	0.2800		0.3117	0.3150
	0.2688	0.2380		0.2883	0.2730		0.3078	0.3080
TL2	0.3055	0.3150	UL2	0.3094	0.3220	VL2	0.3133	0.3290
	0.3094	0.3220		0.3133	0.3290		0.3172	0.3360
	0.3156	0.3220		0.3195	0.3290		0.3234	0.3360
	0.3117	0.3150		0.3156	0.3220		0.3195	0.3290
WL2	0.3172	0.3360	XL2	0.3211	0.3430	YL2	0.3250	0.3500
	0.3211	0.3430		0.3250	0.3500		0.3289	0.3570
	0.3273	0.3430		0.3312	0.3500		0.3351	0.3570
	0.3234	0.3360		0.3273	0.3430		0.3312	0.3500
ZL2	0.3289	0.3570						
	0.3328	0.3640						
	0.3390	0.3640						
	0.3351	0.3570						

If color binning is required, only one color group is allowed for each chip within a reel.
Chromaticity coordinate groups are measured with an accuracy of ± 0.005

Rank	x	y	Rank	x	y	Rank	x	y
AL3	0.2532	0.2100	FL3	0.2727	0.2450	ML3	0.2922	0.2800
	0.2571	0.2170		0.2766	0.2520		0.2961	0.2870
	0.2633	0.2170		0.2828	0.2520		0.3023	0.2870
	0.2594	0.2100		0.2789	0.2450		0.2984	0.2800
BL3	0.2571	0.2170	GL3	0.2766	0.2520	NL3	0.2961	0.2870
	0.2610	0.2240		0.2805	0.2590		0.3000	0.2940
	0.2672	0.2240		0.2867	0.2590		0.3062	0.2940
	0.2633	0.2170		0.2828	0.2520		0.3023	0.2870
CL3	0.2610	0.2240	HL3	0.2805	0.2590	PL3	0.3000	0.2940
	0.2649	0.2310		0.2844	0.2660		0.3039	0.3010
	0.2711	0.2310		0.2906	0.2660		0.3101	0.3010
	0.2672	0.2240		0.2867	0.2590		0.3062	0.2940
DL3	0.2649	0.2310	JL3	0.2844	0.2660	RL3	0.3039	0.3010
	0.2688	0.2380		0.2883	0.2730		0.3078	0.3080
	0.2750	0.2380		0.2945	0.2730		0.3140	0.3080
	0.2711	0.2310		0.2906	0.2660		0.3101	0.3010
EL3	0.2688	0.2380	KL3	0.2883	0.2730	SL3	0.3078	0.3080
	0.2727	0.2450		0.2922	0.2800		0.3117	0.3150
	0.2789	0.2450		0.2984	0.2800		0.3179	0.3150
	0.2750	0.2380		0.2945	0.2730		0.3140	0.3080
TL3	0.3117	0.3150	UL3	0.3156	0.3220	VL3	0.3195	0.3290
	0.3156	0.3220		0.3195	0.3290		0.3234	0.3360
	0.3218	0.3220		0.3257	0.3290		0.3296	0.3360
	0.3179	0.3150		0.3218	0.3220		0.3257	0.3290
WL3	0.3234	0.3360	XL3	0.3273	0.3430	YL3	0.3312	0.3500
	0.3273	0.3430		0.3312	0.3500		0.3351	0.3570
	0.3335	0.3430		0.3374	0.3500		0.3413	0.3570
	0.3296	0.3360		0.3335	0.3430		0.3374	0.3500
ZL3	0.3351	0.3570						
	0.3390	0.3640						
	0.3452	0.3640						
	0.3413	0.3570						

If color binning is required, only one color group is allowed for each chip within a reel.
Chromaticity coordinate groups are measured with an accuracy of ± 0.005

Rank	x	y	Rank	x	y	Rank	x	y
AL4	0.2594	0.2100	FL4	0.2789	0.2450	ML4	0.2984	0.2800
	0.2633	0.2170		0.2828	0.2520		0.3023	0.2870
	0.2695	0.2170		0.2890	0.2520		0.3085	0.2870
	0.2656	0.2100		0.2851	0.2450		0.3046	0.2800
BL4	0.2633	0.2170	GL4	0.2828	0.2520	NL4	0.3023	0.2870
	0.2672	0.2240		0.2867	0.2590		0.3062	0.2940
	0.2734	0.2240		0.2929	0.2590		0.3124	0.2940
	0.2695	0.2170		0.2890	0.2520		0.3085	0.2870
CL4	0.2672	0.2240	HL4	0.2867	0.2590	PL4	0.3062	0.2940
	0.2711	0.2310		0.2906	0.2660		0.3101	0.3010
	0.2773	0.2310		0.2968	0.2660		0.3163	0.3010
	0.2734	0.2240		0.2929	0.2590		0.3124	0.2940
DL4	0.2711	0.2310	JL4	0.2906	0.2660	RL4	0.3101	0.3010
	0.2750	0.2380		0.2945	0.2730		0.3140	0.3080
	0.2812	0.2380		0.3007	0.2730		0.3202	0.3080
	0.2773	0.2310		0.2968	0.2660		0.3163	0.3010
EL4	0.2750	0.2380	KL4	0.2945	0.2730	SL4	0.3140	0.3080
	0.2789	0.2450		0.2984	0.2800		0.3179	0.3150
	0.2851	0.2450		0.3046	0.2800		0.3241	0.3150
	0.2812	0.2380		0.3007	0.2730		0.3202	0.3080
TL4	0.3179	0.3150	UL4	0.3218	0.3220	VL4	0.3257	0.3290
	0.3218	0.3220		0.3257	0.3290		0.3296	0.3360
	0.3280	0.3220		0.3319	0.3290		0.3358	0.3360
	0.3241	0.3150		0.3280	0.3220		0.3319	0.3290
WL4	0.3296	0.3360	XL4	0.3335	0.3430	YL4	0.3374	0.3500
	0.3335	0.3430		0.3374	0.3500		0.3413	0.3570
	0.3397	0.3430		0.3436	0.3500		0.3475	0.3570
	0.3358	0.3360		0.3397	0.3430		0.3436	0.3500
ZL4	0.3413	0.3570						
	0.3452	0.3640						
	0.3514	0.3640						
	0.3475	0.3570						

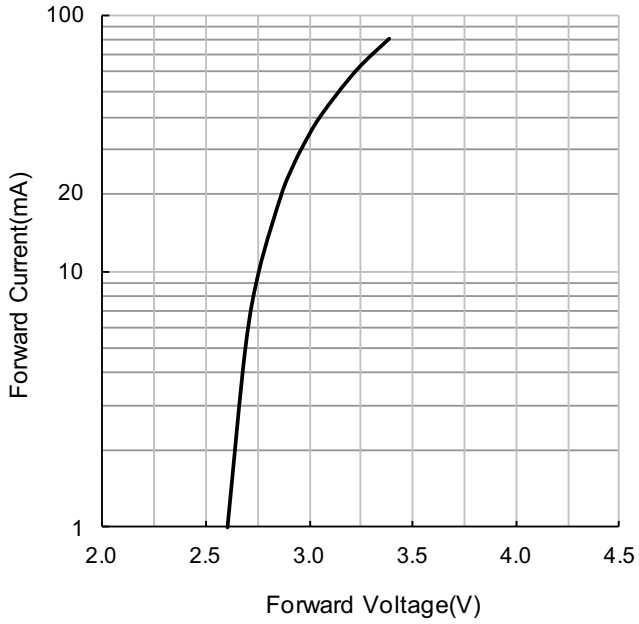
If color binning is required, only one color group is allowed for each chip within a reel.
Chromaticity coordinate groups are measured with an accuracy of ± 0.005

Rank	x	y	Rank	x	y	Rank	x	y
AL5	0.2656	0.2100	FL5	0.2851	0.2450	ML5	0.3046	0.2800
	0.2695	0.2170		0.2890	0.2520		0.3085	0.2870
	0.2757	0.2170		0.2952	0.2520		0.3147	0.2870
	0.2718	0.2100		0.2913	0.2450		0.3108	0.2800
BL5	0.2695	0.2170	GL5	0.2890	0.2520	NL5	0.3085	0.2870
	0.2734	0.2240		0.2929	0.2590		0.3124	0.2940
	0.2796	0.2240		0.2991	0.2590		0.3186	0.2940
	0.2757	0.2170		0.2952	0.2520		0.3147	0.2870
CL5	0.2734	0.2240	HL5	0.2929	0.2590	PL5	0.3124	0.2940
	0.2773	0.2310		0.2968	0.2660		0.3163	0.3010
	0.2835	0.2310		0.3030	0.2660		0.3225	0.3010
	0.2796	0.2240		0.2991	0.2590		0.3186	0.2940
DL5	0.2773	0.2310	JL5	0.2968	0.2660	RL5	0.3163	0.3010
	0.2812	0.2380		0.3007	0.2730		0.3202	0.3080
	0.2874	0.2380		0.3069	0.2730		0.3264	0.3080
	0.2835	0.2310		0.3030	0.2660		0.3225	0.3010
EL5	0.2812	0.2380	KL5	0.3007	0.2730	SL5	0.3202	0.3080
	0.2851	0.2450		0.3046	0.2800		0.3241	0.3150
	0.2913	0.2450		0.3108	0.2800		0.3303	0.3150
	0.2874	0.2380		0.3069	0.2730		0.3264	0.3080
TL5	0.3241	0.3150	UL5	0.3280	0.3220	VL5	0.3319	0.3290
	0.3280	0.3220		0.3319	0.3290		0.3358	0.3360
	0.3342	0.3220		0.3381	0.3290		0.3420	0.3360
	0.3303	0.3150		0.3342	0.3220		0.3381	0.3290
WL5	0.3358	0.3360	XL5	0.3397	0.3430	YL5	0.3436	0.3500
	0.3397	0.3430		0.3436	0.3500		0.3475	0.3570
	0.3459	0.3430		0.3498	0.3500		0.3537	0.3570
	0.3420	0.3360		0.3459	0.3430		0.3498	0.3500
ZL5	0.3475	0.3570						
	0.3514	0.3640						
	0.3576	0.3640						
	0.3537	0.3570						

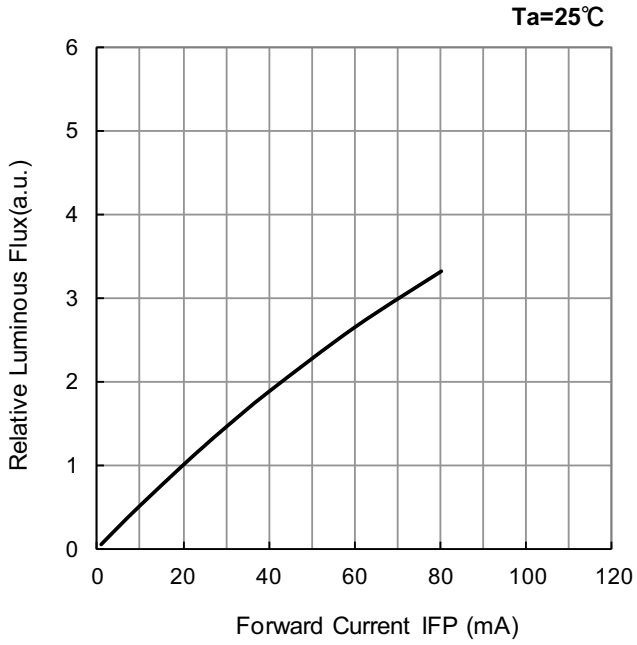
If color binning is required, only one color group is allowed for each chip within a reel.
Chromaticity coordinate groups are measured with an accuracy of ± 0.005

Optical and electrical characteristics

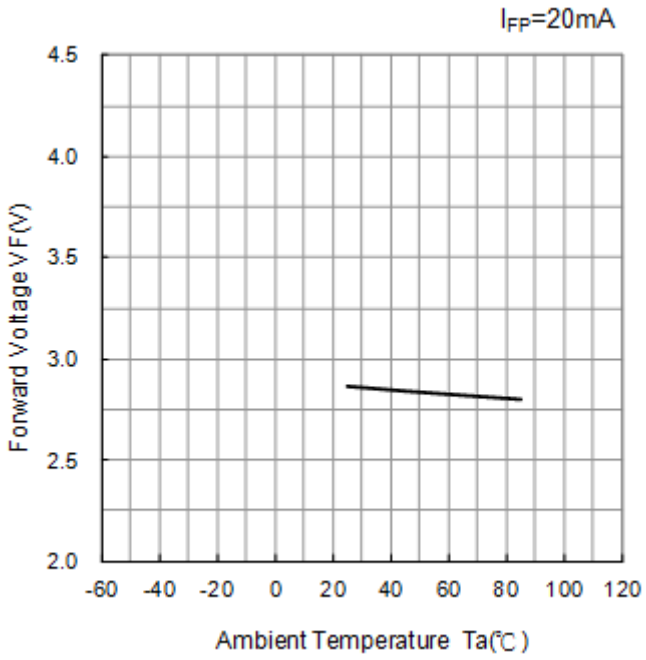
Forward Voltage vs. Forward Current (Ta=25˚C)



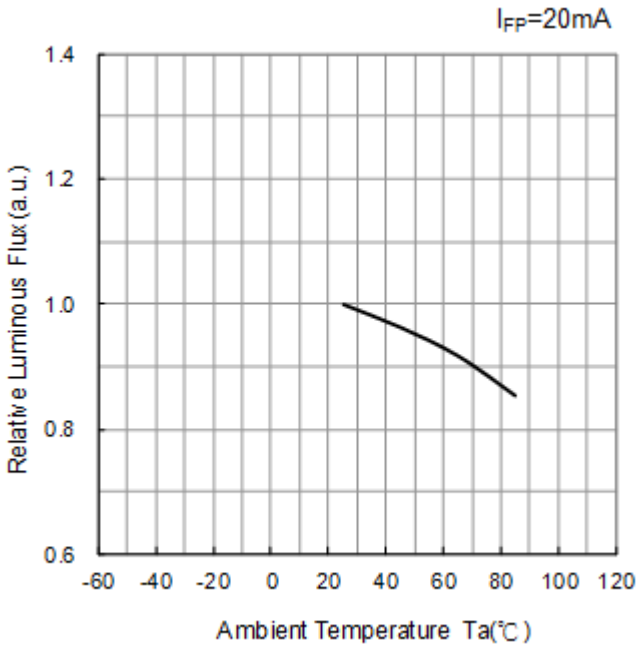
Forward Current vs. Relative Luminous Flux



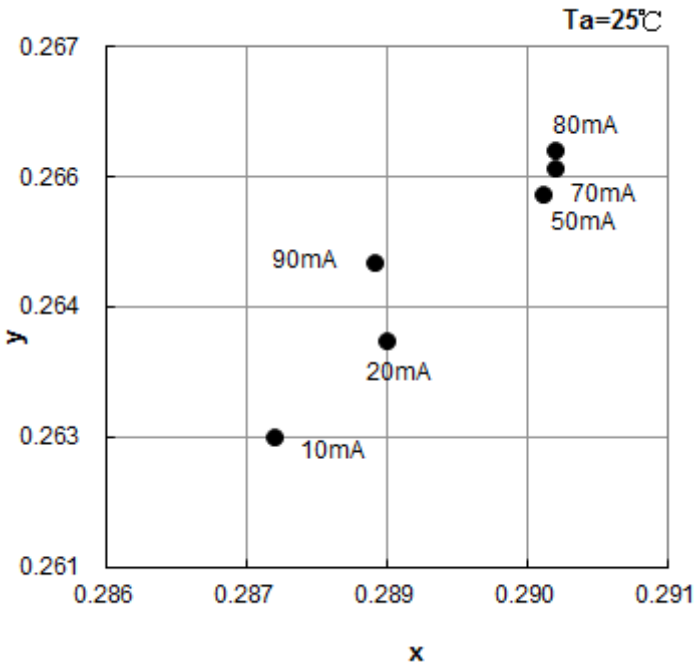
Ambient Temperature vs. Forward Voltage



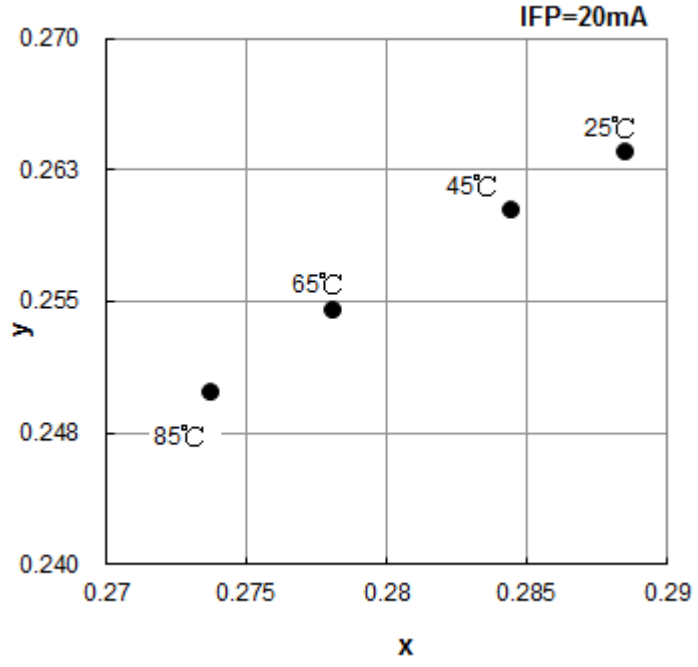
Ambient Temperature vs. Relative Luminous



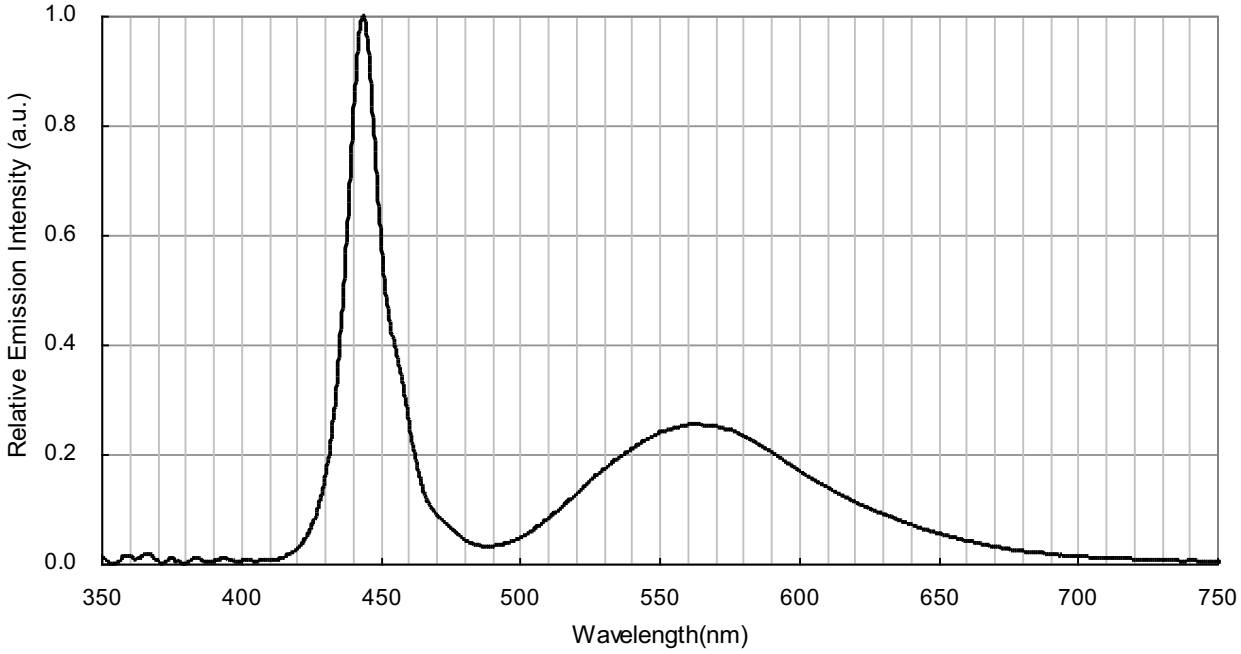
Forward Current vs.Chromaticity Coordinate (T_A =25˚C)



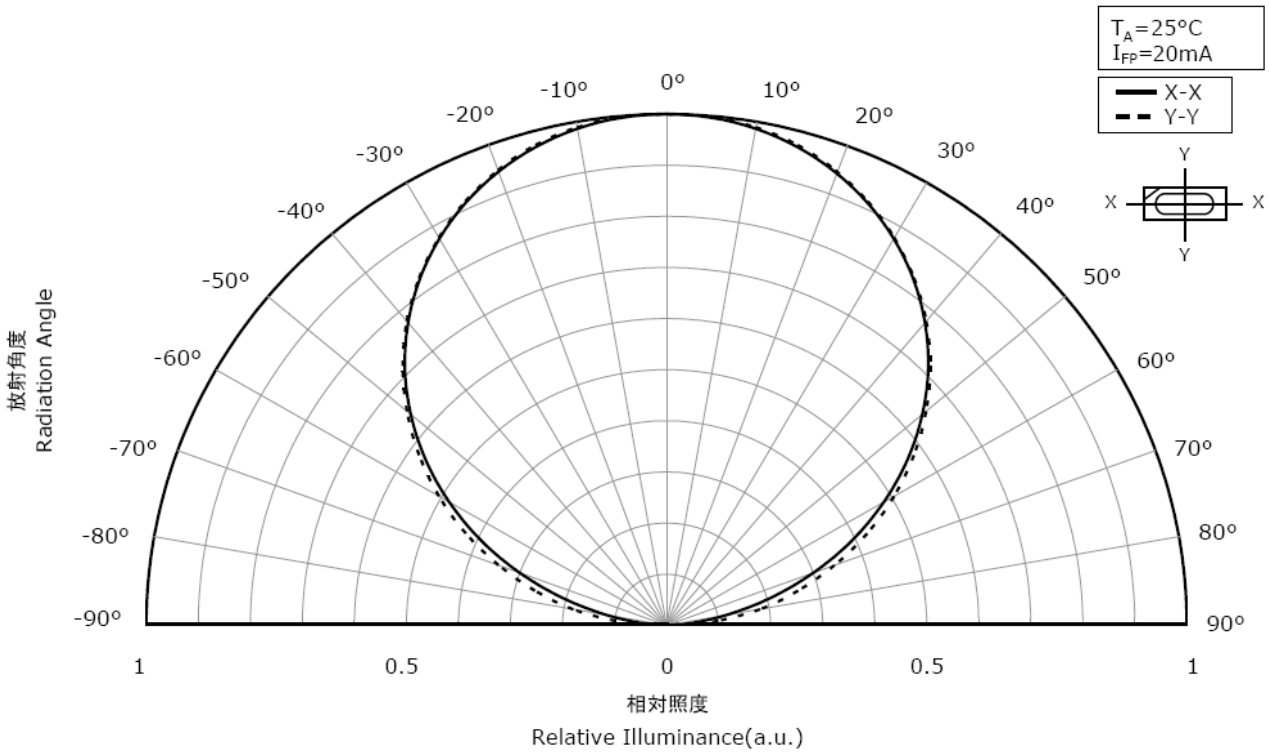
Ambient Temperature vs.Chromaticity Coordinate (I_{FP} =20mA)



Spectrum (T_A=25℃, I_{FP}=20mA)



Radiation Pattern (T_A=25℃, I_{FP}=20mA)



Recommended Reflow Soldering Conditions

Surface Mounting Condition

In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs should be kept min. to prevent them from electrical failures and mechanical damages of the devices.

Soldering Reflow

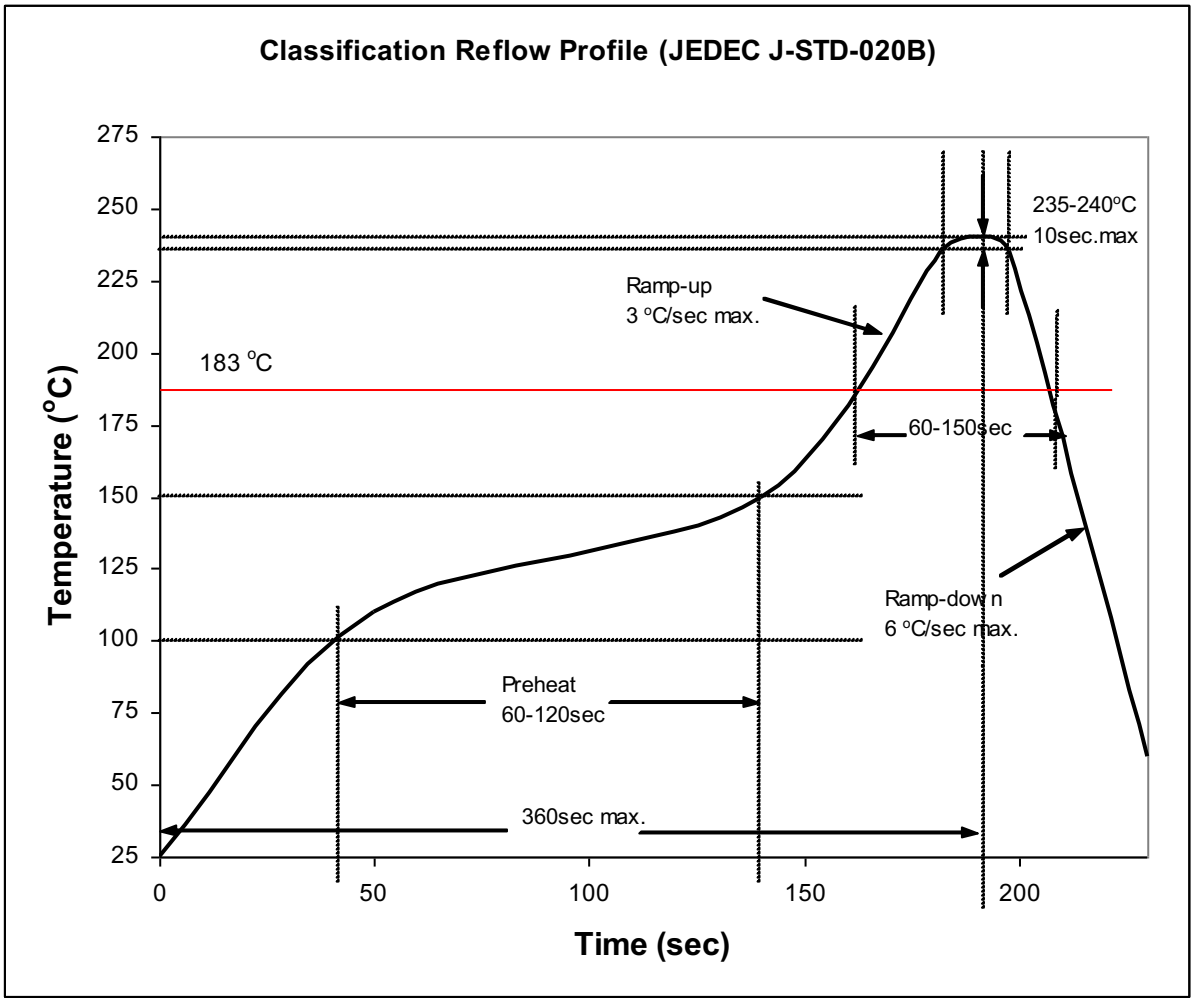
-Soldering of the SMD LEDs should conform to the soldering condition in the individual specifications.

-SMD LEDs are designed for Reflow Soldering.

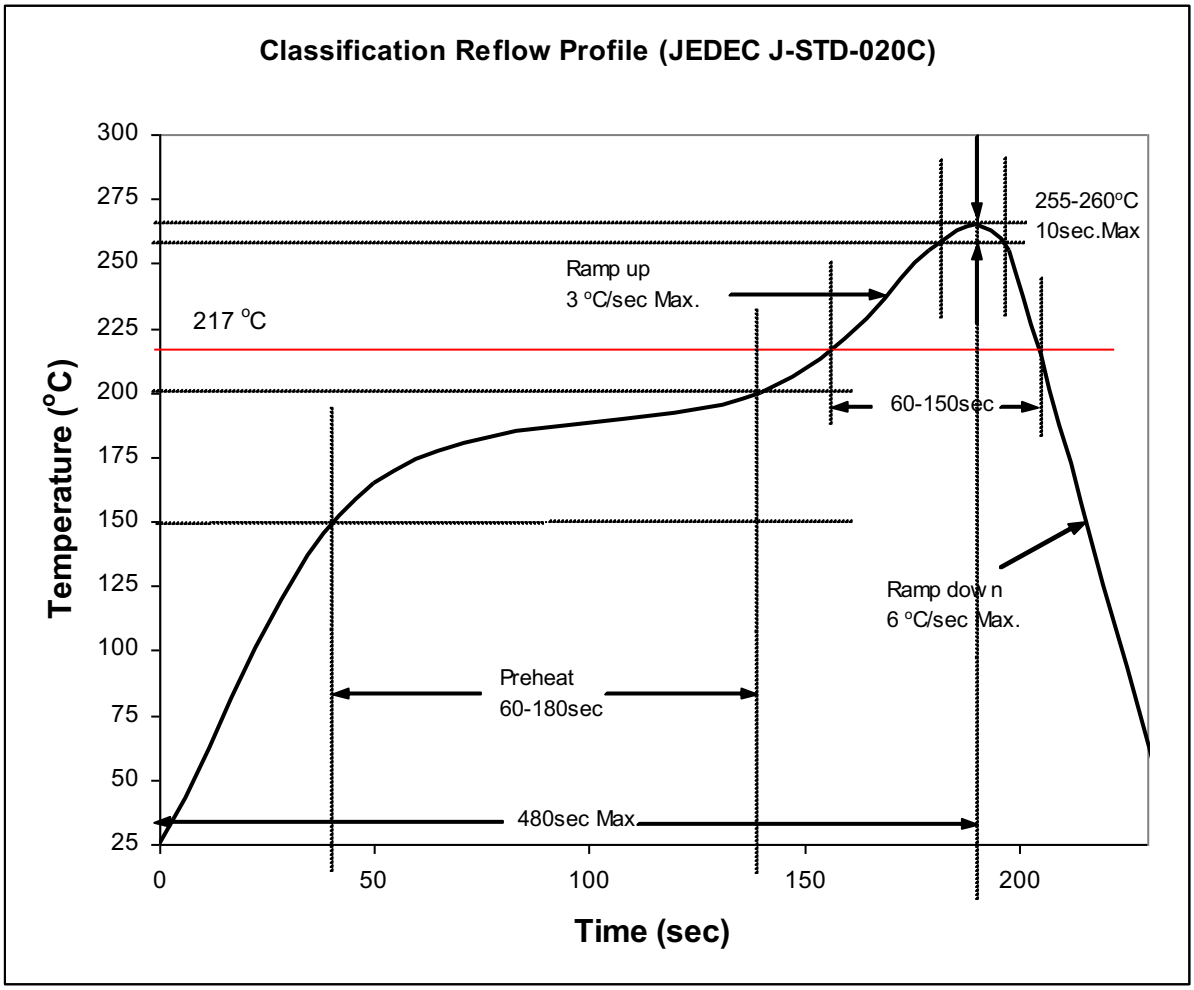
-In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/ cooling may cause electrical & optical failures and damages of the devices.

-AOT cannot guarantee the LEDs after they have been assembled using the solder dipping method.

1) Lead Solder



2) Lead-Free Solder



3) Manual Soldering Conditions

- Lead Solder

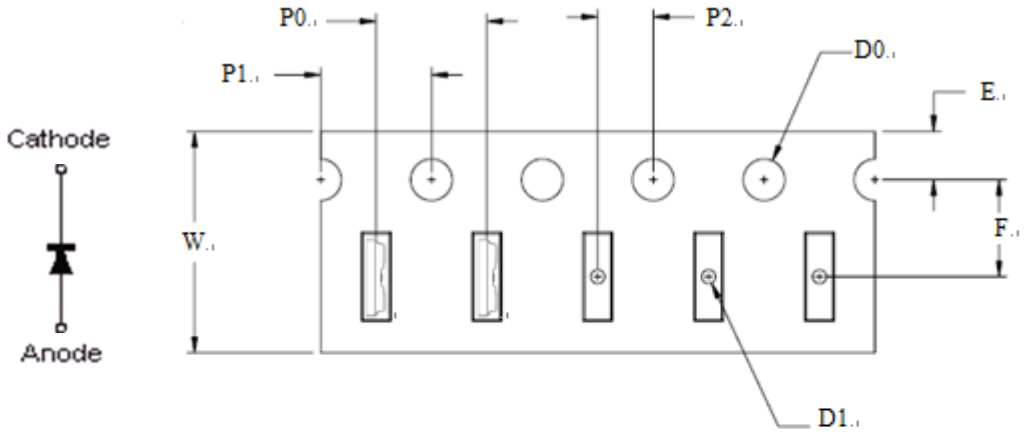
  Max. 300 ˚C for Max. 3sec, and only one time.

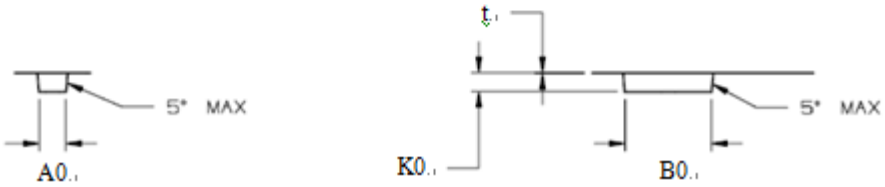
- Lead-free Solder

  Max. 350 ˚C for Max. 3sec, and only one time.

- There is possibility that the brightness of LEDs is decreased, which is influenced by heat or ambient atmosphere during reflow. It is recommended to use the nitrogen reflow method.
- After LEDs have been soldered, repair should not be done. As repair is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will be damaged by repairing or not.
- Reflow soldering should not be done more than two times.

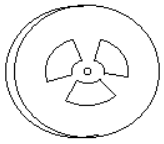
Dimensions (Unit :mm)



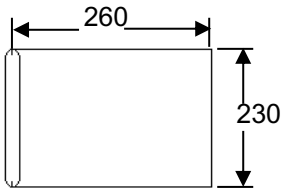


Item	Spec.	Tolerance(mm)	Item	Spec.	Tolerance(mm)
W	8.00	+0.3/-0.1	P2	2.00	±0.05
E	1.75	±0.10	P0x10	40.0	-
F	3.50	±0.05	t	0.20	±0.05
D0	1.50	+0.10/-0.00	A0	0.95	±0.05
D1	0.5	+0.05/-0.00	B0	3.11	±0.05
P0	4.00	±0.10	K0	0.55	±0.05
P1	2.00	±0.05			

Packing Formation

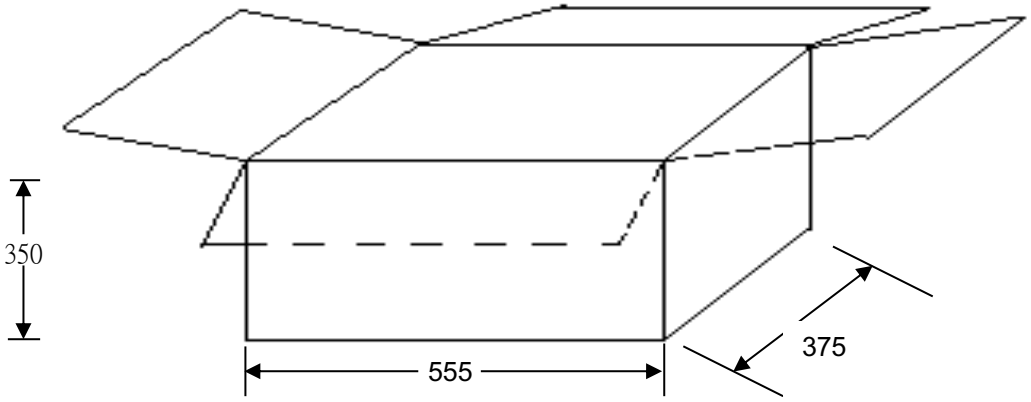


Diameter : 178 mm
Width : 8 mm
3006C-W30F
⇒ 4,000 pcs/Reel

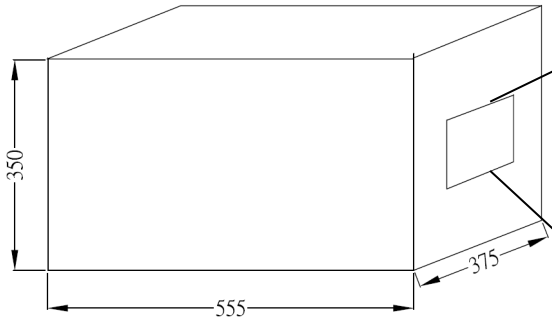


Aluminum Bag, Anti-Static Shielding
1 Reel / Bag (T = 0.1 mm)

90 Aluminum Bag/1 Carton
360,000 pcs/ 1Carton



Package Outlook:



AOT Solid-State Light. Done Right. Advanced Optoelectronic Technology Inc.	
Customer	
PO No.	
Part No.	
Quantity	
Packing Date	
Carton No.	
Ship No.	
QC Check	
備註	

Reel Label Definition

SAP. No.

SMD LED .

Part Number : 3006C-W309

Brightness : A

CIE : B

VF : C

Quantity : nn ea

Serial No : SM0yymmddxxxx

Cust. PN. : XXXXX-XXXX

A : Iv value

B : CIE value noted,

C : Vf value,

nn : Quantity of LED

SM0yymmddxxx : yy : year, mm : month, dd : day, xxxx : reel no

*Reel Label to fill in practice data of all LED characteristic

Reliability Test

No.	Test Item	Standard Test Method	Test Condition	Note	Number of Damaged
1	Room Temp. Life Test	Internal Ref.	T_A=25℃,I_F=20mA	1000hrs	0/20
2	High Temp. Operating	JESD22-A108	T_A=65℃,I_F=20mA	1000hrs	0/20
3	High Temp. Operating	JESD22-A108	T_A=85℃,I_F=8.5mA	1000hrs	0/20
4	High Temp. Storage	JESD22-A103	T_A=100℃	1000hrs	0/20
5	Low Temp. Operating	JESD22-A108	T_A=-40℃,I_F=20mA	1000hrs	0/20
6	High Temp. and High Humidity Operation	JESD22-A119	60℃ 95%RH, I_F =20mA	1000hrs	0/20
7	Temperature and humidity cycle test	IEC68-2-38	25°C ~65°C ~-10°C,90% RH 24hr per cycle	10 cycle	0/20
8	Thermal Cycle Test	JESD22-A106	100℃ 30min~ -40℃ 30min Transform time 5min	300cycles	0/20

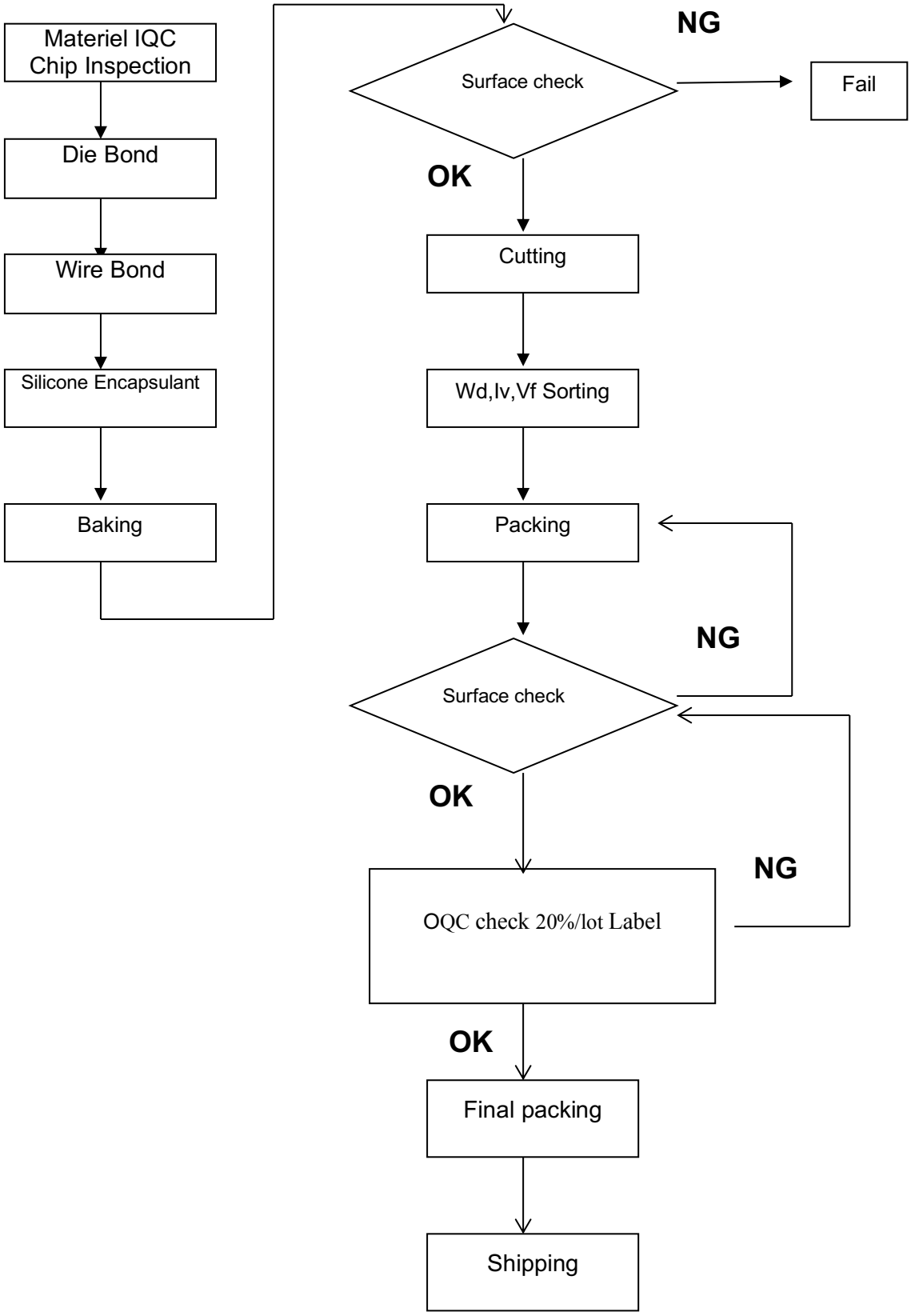
Criteria for Judging Damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	V_F	I_F =20mA	-	*U.S.L×1.1
Reverse Current	I_R	V_R =5V	-	*U.S.L×2.0
Luminous Intensity	I_V	I_F =20mA	*L.S.L×0.7	-

* U.S.L: Upper Standard Level
* L.S.L: Lower Standard Level

Solid-State Light. Done Right.

Side View Process Flow



CAUTIONS

(1) Moisture Proof Package

The moisture proof package should be used to prevent moisture in the package as the moisture may Cause damage to optical characteristics of the LEDs.

The aluminum bag with zipper is used for moisture proof package. And, the moisture absorbent Material, Silica gel, is inserted into aluminum bag.

(2) Storage:

Storage Conditions

Before opening the package:

The LEDs should be kept at 30˚C or less than 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended.

After opening the package:

After open the package, the LED should be kept at 30˚C, 60%RH or less. The LED should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, it should be stored in moisture proof condition.

(3) Heat Generation

Thermal design of the end products is of paramount importance. The heat generation must be taken into design consideration when using the LED. The coefficient of the temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components.

(4) Static Electricity

Static electricity or surge voltage damages the LEDs. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LEDs. When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a Vf test at a lower current. (Below 1mA is recommended).

Criteria: Vf >1.9V at If=1 μA

(5) Cleaning

Use isopropyl alcohol as a solvent for cleaning the LEDs. The other solvent may dissolve the LEDs package and the epoxy.

Ultrasonic cleaning should not be done.

(6) Electrostatic Discharge (ESD)

The products are sensitive to static electricity or surge voltage, An ESD event may damage its die or reduce its reliability performance. When handling the products, measures against electro static discharge, including the followings, are strongly recommended.

Eliminating the charge;

Wrist strap, ESD footwear and garments, ESD floors

Grounding the equipment and tools at workstation

ESD table / shelf mat (conductive materials)

Proper grounding techniques are required for all devices, equipment and machinery used in the assembly of the products, Also note that surge protection should be considered in the design of customer products.
If tools or equipment contain insulating materials, such as glass or plastic, proper measures against electro static discharge, including the followings are strongly recommended.

Dissipating the charge with conductive materials

Preventing the charge generation with moisture

Neutralizing the charge with ionizer

(7) Others

When using the LEDs, it must care that the reverse voltage will not exceed the absolute maximum rating.
The LED light is enough to injure human eyes, so it should avoid looking at LED light directly.

NOTE.

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